

# WCNLB8-R611

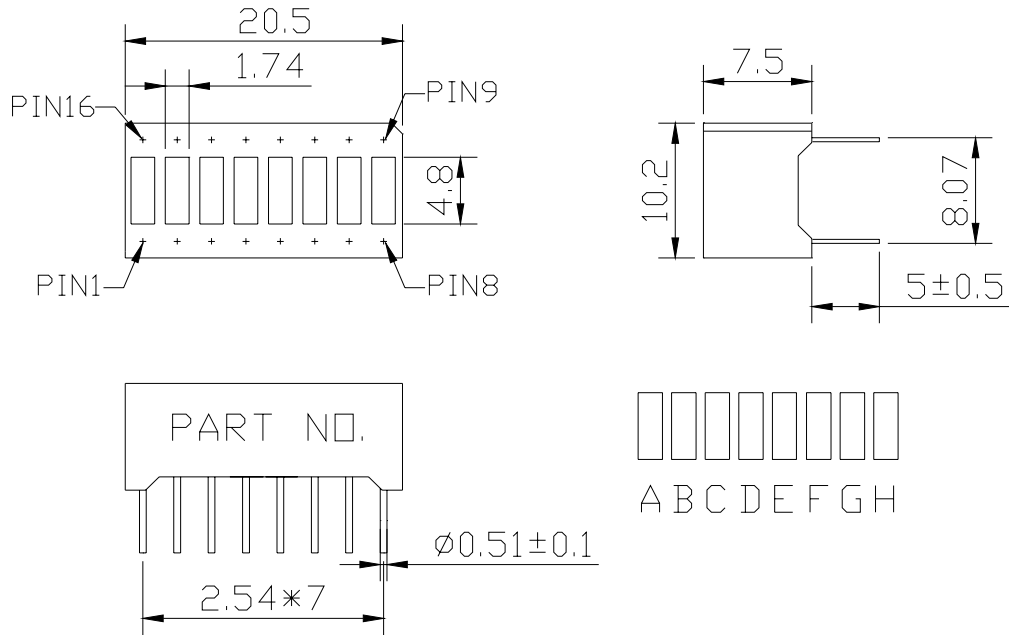
## SPECIFICATION

WCN			CUSTOMER Confirmed
Prepared by	Checked by	Approved by	
Fei 2016-8-4	Athena	William	
REVISION RECORD			



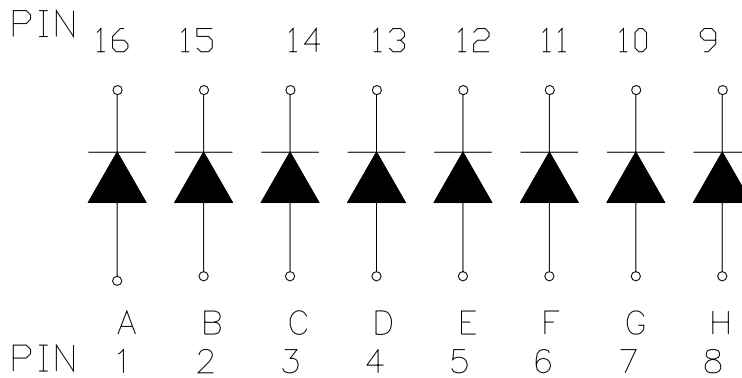
REVISION: A0

## Outer Dimension:



Notes: Unless otherwise stated, The tolerance is  $\pm 0.25$ mm.

## Circuit Diagram:



## Pin Connection:

PIN NO.	CONNECTION	PIN NO.	CONNECTION	PIN NO.	CONNECTION
1	Anode A	7	Anode G	13	Cathode D
2	Anode B	8	Anode H	14	Cathode C
3	Anode C	9	Cathode H	15	Cathode B
4	Anode D	10	Cathode G	16	Cathode A
5	Anode E	11	Cathode F	/	/
6	Anode F	12	Cathode E	/	/

■ **Features:**

- High Reliability
- Color: Super Bright Red.
- Low Power Requirement
- Easy Assembly

■ **Description:**

- Eight Windows Display
- Digit Height 4.80mm(0.19" ) and Width 1.74mm(0.07" )
- Black Face and Milky Bar

■ **Absolute Maximum Rating (Ta=25°C):**

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation Per Bar	P <sub>d</sub>	—	Red	65	mW
Forward Current Per Bar	I <sub>F</sub>	—	Red	25	mA
Peak Forward Current Per Bar	I <sub>FP</sub>	1/10 Duty 10KHz	Red	100	mA
Reverse Voltage Per Bar	V <sub>R</sub>	—	Red	5	V
Operating Temperature Range	Topr	—	—	-35~+85	°C
Storage Temperature Range	Tstg	—	—	-35~+85	°C

■ **Electrical/Optical Characteristics Rating(Ta=25°C)**

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	Per Bar	—	2.00	2.60	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	Per Bar	—	—	100	μA
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> =10mA	Per Bar	7201	11500	18000	μcd
Wave Length	λ <sub>P</sub>	I <sub>F</sub> =20mA	Per Bar	—	635	—	nm
	λ <sub>D</sub>				630		
Spectral Line Half Width	△λ	I <sub>F</sub> =20mA	Per Bar	—	30	—	nm
Luminous Intensity Matching Ratio (Bar to Bar)	I <sub>v-m</sub>	I <sub>F</sub> =10mA				1.2:1	

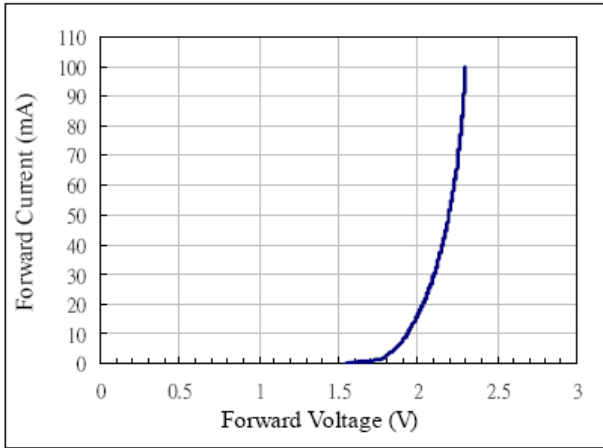
■ **Luminous Intensity Sorting: (Luminous Intensity Tolerance is +/-10%)**

Rank	Symbol	Condition	Min	Max	Unit
O	O	I <sub>F</sub> =10mA	7201	8500	μcd
P	P	I <sub>F</sub> =10mA	8501	10500	μcd
Q	Q	I <sub>F</sub> =10mA	10501	12800	μcd
R	R	I <sub>F</sub> =10mA	12801	15250	μcd
S	S	I <sub>F</sub> =10mA	15251	18000	μcd

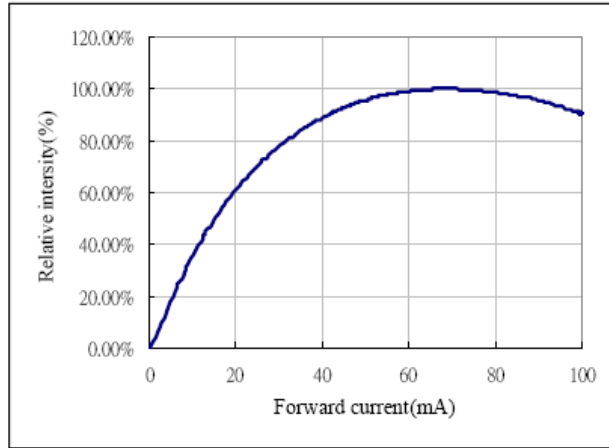
■ **Soldering Conditions: Soldering Temp. ≤ +260°C Soldering Time. ≤ 3sec.**  
 (at 2mm Distance from The Case of Reflector Edge).

■ **Typical Elector-Optical Characteristics Curve:**

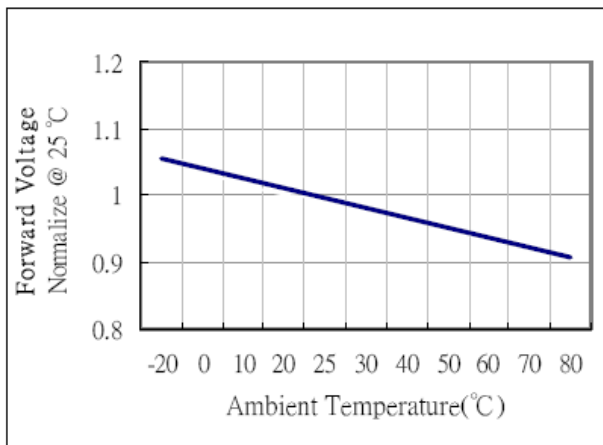
Forward current vs. Forward voltage



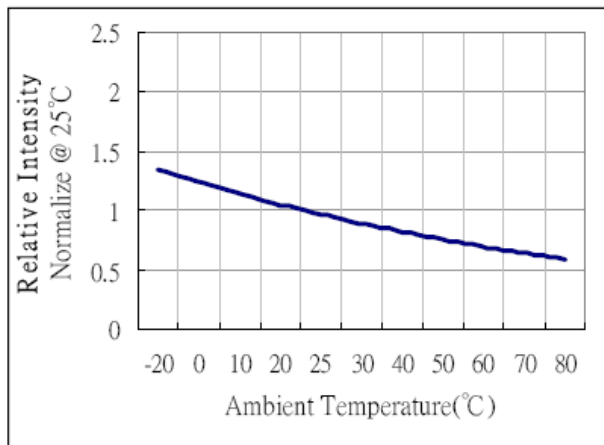
Relative intensity vs. Forward current



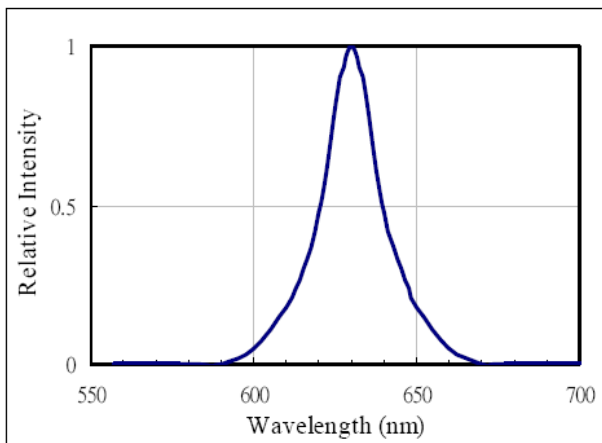
Forward voltage vs. Temperature



Relative intensity vs. Temperature



Relative intensity vs. Wavelength



## ■ LED Displays Reliability Test:

CLASSIFICATION	TEST ITEM	DESCRIPTION AND TEST CONDITION
ENDURANCE TEST	OPERATION LIFE	EVALUATES RESISTANCE OF THE DEVICE WHEN OPERATED AT ELECTRICAL STRESS $T_a$ = UNDER ROOM TEMPERATURE $I_f = I_{f \text{ max}}$
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	EVALUATES MOISTURE RESISTANCE OF THE DEVICE WHEN STORED FOR A LONG TERM AT HIGH TEMPERATURE AND HUMIDITY $T_a = 65 \pm 5^\circ\text{C}$ RH=90~95%RH TEST TIME=240± 2Hrs
	HIGH TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN HIGH TEMPERATURE $T_a = 85 \pm 5^\circ\text{C}$ (COB: $T_a = 65 \pm 5^\circ\text{C}$ ) TEST TIME=1000Hrs(-24Hrs, +72Hrs)
	LOW TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN LOW TEMPERATURE $T_a = -35 \pm 5^\circ\text{C}$ TEST TIME=1000Hrs(-24Hrs, +72Hrs)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	EVALUATES RESISTANCE OF DEVICE AT THERMAL STRESSES OR EXPANSION AND CONTRACTION $85^\circ\text{C} \sim 25^\circ\text{C} \sim -35^\circ\text{C} \sim 25^\circ\text{C}$ 30min 5min 30min 5min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$ , $T_{\text{cold}}=-25^\circ\text{C}$ )
	THERMAL SHOCK	EVALUATES DEVICE STRUCTURE AND STRUCTURE AND MECHANICAL RESISTANCE WHEN SUDDENLY EXPOSED AT SERVE CHANGES $85 \pm 5^\circ\text{C} \sim -35 \pm 5^\circ\text{C}$ 10min 10min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$ , $T_{\text{cold}}=-25^\circ\text{C}$ )
	SOLDERABILITY	EVALUATES SOLDERABILITY ON LEADS OF DEVICE $T_{\text{SOL}}=230 \pm 5^\circ\text{C}$ DWELL TIME=5±1sec.
	SOLDER RESISTANCE	EVALUATES RESISTANCE TO THERMAL STRESS CAUSED BY SOLDERING $T_{\text{SOL}}=260 \pm 5^\circ\text{C}$ DWELL TIME=10±1sec.

## ■ Packing method A:

224pcs / Red Expandable Polyethylene.

1340 pcs / Box(360\*175\*130mm).

8040 pcs / Catton(550\*380\*280mm).

## ■ Packing method B:

25 pcs / IC Tube.

1925 pcs / Box(537\*175\*125mm).

7700 pcs / Catton(550\*380\*280mm).